

**MOSFET** PG-T0247-3

### StrongIRFET™ Power MOSFET, 100 V

#### **Features**

- Optimized Q<sub>rr</sub>
- 175°C operating temperature
- Product validation according to JEDEC standard
- Optimized for broadest availability from distribution partners

### **Benefits**

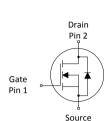
- Reduced conduction losses
- Ideal for high switching frequency
- Lower overshoot voltage
- Increased reliability versus 150°C rated parts
- Pb-free lead plating; RoHS compliant
- Lead free, Halogen-free according to IEC61249-2-21



Fully qualified according to JEDEC for Industrial Applications

Table 1 Key performance parameters

Parameter	Value	Unit
$V_{ m DS}$	100	V
$R_{\mathrm{DS(on),max}}$	1.7	mΩ
$I_{D}$	203	А
Q <sub>oss</sub>	213	nC
Q <sub>G</sub> (0V10V)	168	nC





Pin 3

Related links	

Type / Ordering code	Package	Marking	Related links
IRF100PW219	PG-T0247-3	100PW219	-

### Public

# StrongIRFET™ Power MOSFET, 100 V IRF100PW219



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# StrongIRFET™ Power MOSFET, 100 V IRF100PW219



## 1 Maximum ratings

at  $T_{\Delta}$ =25 °C, unless otherwise specified

Table 2 Maximum ratings

Parameter	Symbol	Values			Linit	Note / Test condition
raiametei	Syllibot	Min.	Тур.	Max.		Note / Test condition
Continuous drain current <sup>1)</sup>	I <sub>D</sub>	-	-	203 156 33	А	$V_{\rm GS}$ =10 V, $T_{\rm C}$ =25 °C $V_{\rm GS}$ =10 V, $T_{\rm C}$ =100 °C $V_{\rm GS}$ =10 V, $T_{\rm A}$ =25 °C, $R_{\rm THJA}$ =40 °C/W <sup>2)</sup>
Pulsed drain current <sup>3)</sup>	I <sub>D,pulse</sub>	_	-	812	Α	<i>T</i> <sub>C</sub> =25 °C
Avalanche energy, single pulse <sup>4)</sup>	E <sub>AS</sub>	-	-	464	mJ	$I_{\rm D}$ =100 A, $R_{\rm GS}$ =25 $\Omega$
Gate source voltage	$V_{\rm GS}$	-20	-	20	V	-
Power dissipation	$P_{\rm tot}$	-	-	341 3.8	W	$T_{\rm C}$ =25 °C $T_{\rm A}$ =25 °C, $R_{\rm THJA}$ =40 °C/W <sup>2)</sup>
Operating and storage temperature	$T_{\rm j}$ , $T_{\rm stg}$	-55	-	175	°C	-

<sup>1)</sup> Rating refers to the product only with datasheet specified absolute maximum values, maintaining case temperature as specified. For other case temperatures please refer to Diagram 2. De-rating will be required based on the actual environmental conditions

Device on 40 mm x 40 mm x 1.5 mm epoxy PCB FR4 with 6 cm $^2$  (one layer, 70  $\mu$ m thick) copper area for drain connection. PCB is vertical in still air.

<sup>3)</sup> See Diagram 3 for more detailed information:

<sup>4)</sup> See Diagram 13 for more detailed information.



## 2 Thermal characteristics

Table 3 Thermal characteristics

Darameter	Symbol	Values			Limit	Note / Test condition
Parameter	Symbol	Min.	Тур.	Max.	Oilit	Note / Test condition
Thermal resistance, junction - case	$R_{\mathrm{thJC}}$	-	0.3	0.44	°C/W	
Thermal resistance, junction - ambient <sup>5)</sup>	$R_{thJA}$	-	-	40	°C/W	-
Case-to-Sink, Flat Greased Surface	R <sub>thCS</sub>	-	0.24	-	°C/W	

Device on 40 mm x 40 mm x 1.5 mm epoxy PCB FR4 with 6 cm $^2$  (one layer, 70  $\mu$ m thick) copper area for drain connection. PCB is vertical in still air.

# StronglRFET™ Power MOSFET, 100 V IRF100PW219



## 3 Electrical characteristics

at  $T_i$ =25 °C, unless otherwise specified

Table 4 Static characteristics

Parameter	Symbol	Values			Unit	Note / Test condition
rarameter	Syllibol	Symbol Min. Typ. Max.		Joint	Note / Test condition	
Drain-source breakdown voltage	V <sub>(BR)DSS</sub>	100	-	-	V	$V_{\rm GS}$ =0 V, $I_{\rm D}$ =1 mA
Gate threshold voltage	$V_{\rm GS(th)}$	2.3	3.0	3.8	V	$V_{\rm DS} = V_{\rm GS}, I_{\rm D} = 278 \mu{\rm A}$
Zero gate voltage drain current	I <sub>DSS</sub>	-	0.1 10	1 100	μΑ	$V_{\rm DS}$ =100 V, $V_{\rm GS}$ =0 V, $T_{\rm j}$ =25 °C $V_{\rm DS}$ =100 V, $V_{\rm GS}$ =0 V, $T_{\rm j}$ =125 °C
Gate-source leakage current	I <sub>GSS</sub>	-	10	100	nA	$V_{\rm GS}$ =20 V, $V_{\rm DS}$ =0 V
Drain-source on-state resistance	$R_{\rm DS(on)}$	-	1.4 1.7	1.7 2.1	mΩ	$V_{GS}$ =10 V, $I_{D}$ =100 A $V_{GS}$ =6 V, $I_{D}$ =50 A
Gate resistance	R <sub>G</sub>	-	1.2	-	Ω	-
Transconductance <sup>6)</sup>	$g_{fs}$	135	270	-	S	$ V_{\rm DS}  \ge 2 I_{\rm D} R_{\rm DS(on)max}, I_{\rm D} = 100 \text{ A}$

<sup>6)</sup> Defined by design. Not subject to production test.

Table 5 Dynamic characteristics

Parameter	Symbol	Values			Linit	Note / Test condition
rarameter	Syllibot	Min.	Тур.	Max.	Oilit	Note / Test condition
Input capacitance <sup>7)</sup>	$C_{\rm iss}$	_	12000	16000	pF	
Output capacitance <sup>7)</sup>	Coss	-	1800	2300	pF	$V_{\rm GS}$ =0 V, $V_{\rm DS}$ =50 V, $f$ =1 MHz
Reverse transfer capacitance <sup>7)</sup>	C <sub>rss</sub>	-	80	140	pF	
Turn-on delay time	$t_{\sf d(on)}$	-	67	-	ns	
Rise time	t <sub>r</sub>	-	106	-	ns	$V_{\rm DD}$ =50 V, $V_{\rm GS}$ =10 V, $I_{\rm D}$ =100 A,
Turn-off delay time	$t_{\sf d(off)}$	-	132	-	ns	$R_{\rm G,ext}$ =1.6 $\Omega$
Fall time	$t_{f}$	-	47	-	ns	

<sup>&</sup>lt;sup>7)</sup> Defined by design. Not subject to production test.

# StrongIRFET™ Power MOSFET, 100 V IRF100PW219



Table 6 Gate charge characteristics 8)

Parameter	Symbol	Values			Unit	Note / Test condition
Parameter	Symbol	Min.	Тур.	Max.	Onit	Note / Test condition
Gate to source charge	$Q_{\rm gs}$	-	53	-	nC	
Gate charge at threshold	$Q_{\mathrm{g(th)}}$	-	36	-	nC	
Gate to drain charge <sup>9)</sup>	$Q_{\mathrm{gd}}$	-	34	51	nC	$V_{\rm DD}$ =50 V, $I_{\rm D}$ =100 A, $V_{\rm GS}$ =0 to 10 V
Switching charge	$Q_{\rm sw}$	-	51	-	nC	
Gate charge total <sup>9)</sup>	$Q_{ m g}$	-	168	210	nC	
Gate plateau voltage	$V_{ m plateau}$	-	4.4	-	V	
Gate charge total, sync. FET	$Q_{\rm g(sync)}$	-	146	-	nC	V <sub>DS</sub> =0.1 V, V <sub>GS</sub> =0 to 10 V
Output charge <sup>9)</sup>	Q <sub>oss</sub>	-	213	320	nC	V <sub>DS</sub> =50 V, V <sub>GS</sub> =0 V

<sup>8)</sup> See figure 16 for gate charge parameter definition:

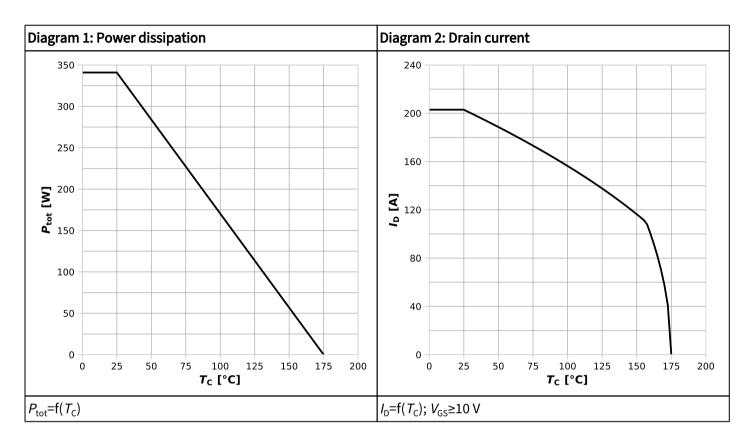
### Table 7 Reverse diode

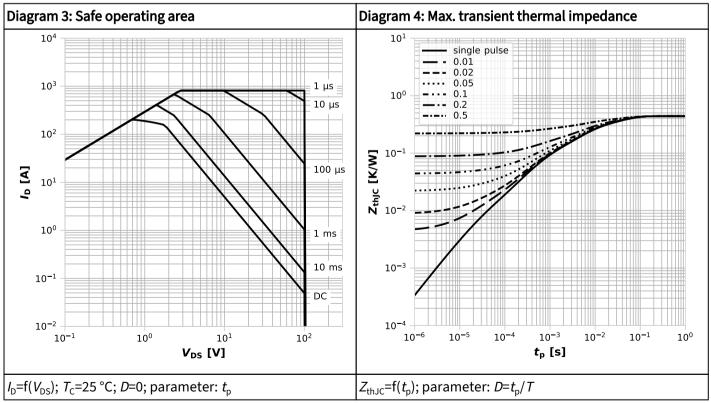
Parameter	Symbol	Values			1154	Note / Test condition	
raiailletei	Symbol	Min.	Тур.	Max.	Onic	Note / Test condition	
Diode continuous forward current	I <sub>S</sub>	-	-	173	А	<i>T</i> <sub>C</sub> =25 °C	
Diode pulse current	I <sub>S,pulse</sub>	-	-	812	Α		
Diode forward voltage	$V_{\rm SD}$	-	0.86	1.0	V	$V_{\rm GS}$ =0 V, $I_{\rm F}$ =100 A, $T_{\rm j}$ =25 °C	
Reverse recovery time	t <sub>rr</sub>	-	63	-	ns	V =50 V I =100 A di /d <del>←</del> 100 A/uc	
Reverse recovery charge	$Q_{\rm rr}$	-	111	-	nC	$V_{R}$ =50 V, $I_{F}$ =100 A, d $I_{F}$ /d $t$ =100 A/ $\mu$ s	

<sup>9)</sup> Defined by design. Not subject to production test.

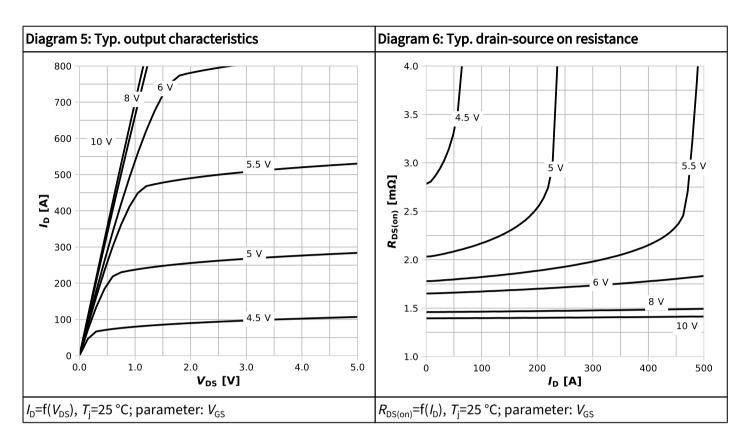


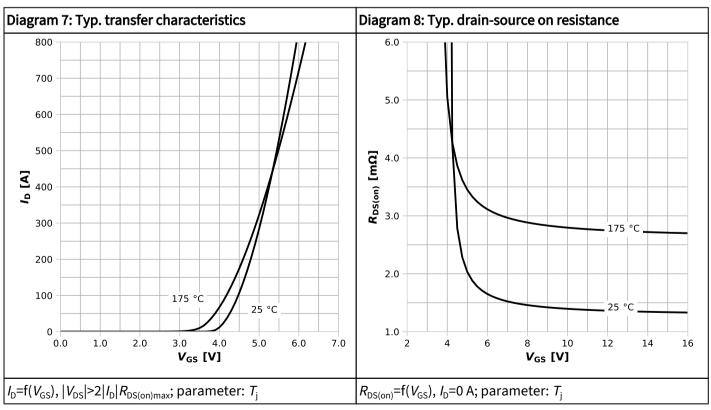
## 4 Electrical characteristics diagrams



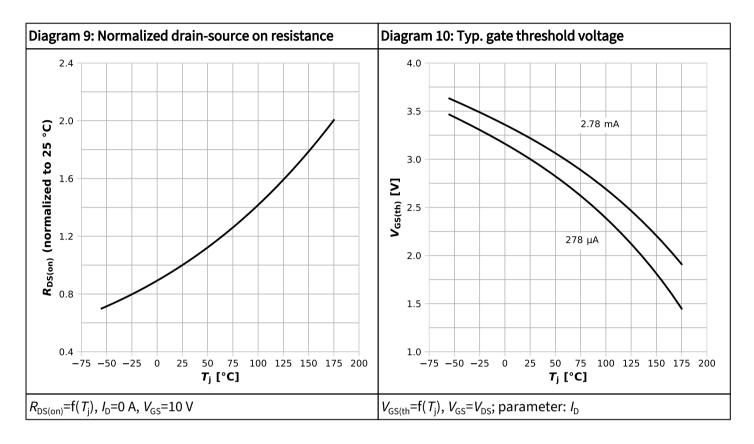


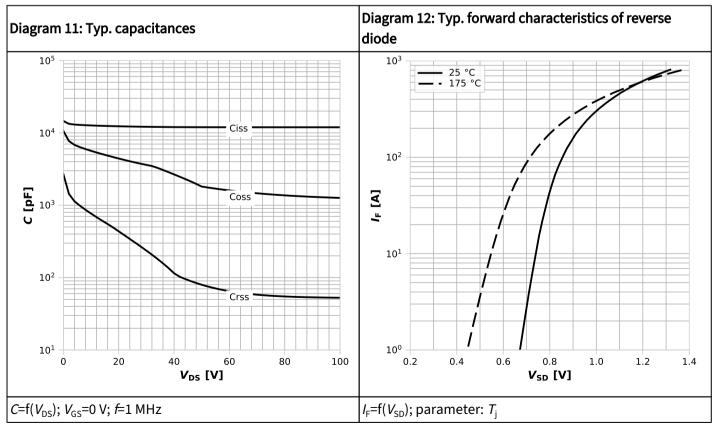




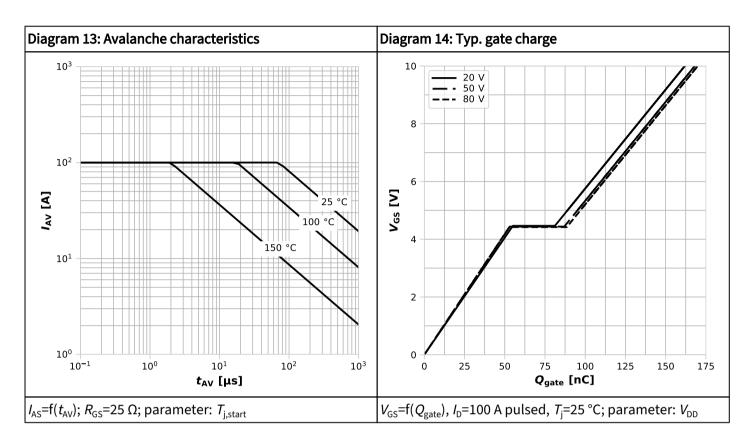


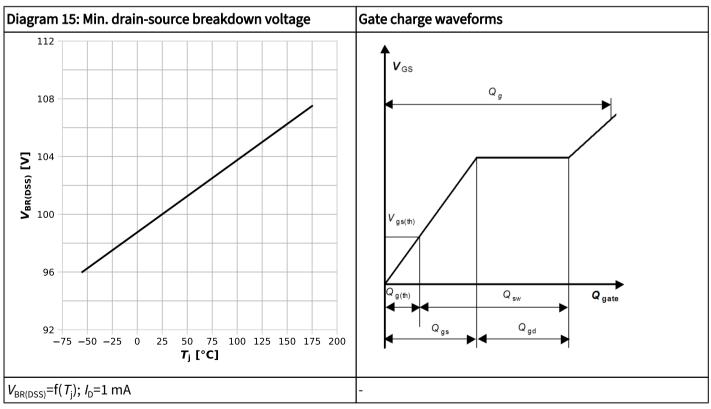






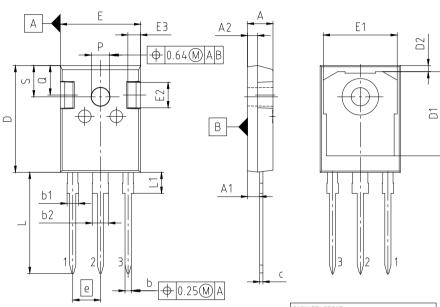








## 5 Package outlines



PACKAGE - GROUP NUMBER:	PG-TO2	PG-TO247-3-U06					
DIMENSIONS	MILLIM	IETERS					
DIMENSIONS	MIN.	MAX.					
Α	4.83	5.21					
A1	2.27	2.54					
A2	1.85	2.16					
b	1.07	1.33					
b1	1.90	2.41					
b2	2.87	3.38					
С	0.55	0.68					
D	20.80	21.10					
D1	16.25	17.65					
D2	0.95	1.35					
E	15.70	16.13					
E1	13.10	14.15					
E2	3.68	5.10					
E3	1.00	2.60					
е	5.44						
N	3						
L	19.80	20.32					
L1	3.95	4.47					
øΡ	3.50	3.70					
Q	5.49	6.00					
s	6.04	6.30					

NOTE:

DIMENSIONS DO NOT INCLUDE MOLDFLASH; PROTRUSION OR GATE BURRS

Figure 1 Outline PG-TO247-3, dimensions in mm

# StrongIRFET™ Power MOSFET, 100 V IRF100PW219



### **Revision history**

IRF100PW219

#### Revision 2025-01-10, Rev. 2.0

Previous revisions

Revision	Date	Subjects (major changes since last revision)
2.0	2025-01-10	Release of final datasheet

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